

CP2301CI

-20V P-Channel Enhancement Mode MOSFET

Description

The CP2301CI uses advanced trench technology to provide excellent RDS(ON), low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

VDS = -20V ID =-2.3A

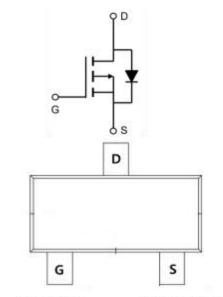
R_{DS(ON)} < 150mΩ @ V_{GS}=-4.5V (Type: 125mΩ)

Application

Battery protection

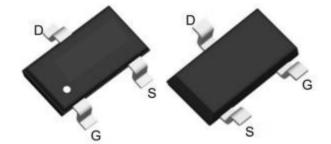
Load switch

Uninterruptible power supply



Top View

Bottom View



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)	
CP2301CI	SOT23L	A1SHB	3000	

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	-20	V
Vgs	Gate-Source Voltage	±12	V
lo@Ta=25℃	Continuous Drain Current, V _{GS} @ -4.5V ¹	-2.3	А
lo@Ta=70°C	Continuous Drain Current, V _{GS} @ -4.5V ¹	-0.9	А
Ідм	Pulsed Drain Current ²	-7.4	А
PD@TA=25°C	Total Power Dissipation ³	1.1	w
PD@TA=70°C	Total Power Dissipation ³	0.6	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R₀JA	Thermal Resistance Junction-Ambient ¹	125	°C/W
R0JC	Thermal resistance, junction-case	32	°C/W



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Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V(BR)DSS	Drain-Source Breakdown Voltage	Vgs=0V,Id= -250µA	-20	-	-	V
IDSS	Zero Gate Voltage Drain Current	V _{DS} = -20V, V _{GS} = 0V,	-	-	-1	μA
IGSS	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} = ±12V	-	-	±100	nA
VGS(th)	Gate Threshold Voltage	Vos= Vgs, Io= -250µA	-0.4	-0.7	-1.0	V
	Static Drain-Source on-Resistance	Vgs =-4.5V, Id =-2A	-	125	150	mΩ
RDS(on)		Vgs =-2.5V, Id =-1A	-	145	180	
Ciss	Input Capacitance	V _{DS} = -10V, V _{GS} = 0V, f = 1.0MHz	-	145	-	pF
Coss	Output Capacitance		-	33	-	pF
Crss	Reverse Transfer Capacitance		-	23	-	pF
Qg	Total Gate Charge	V _{DS} = -10V, I _D = -2A, V _{GS} = -4.5V	-	4.5	-	nC
Qgs	Gate-Source Charge		-	0.85	-	nC
Qgd	Gate-Drain("Miller") Charge		-	1.4	-	nC
td(on)	Turn-on Delay Time	Vdd = -10V, RL=5Ω, Rgen=3Ω,Vgs=-4.5V,	-	6	-	ns
tr	Turn-on Rise Time		-	30	-	ns
td(off)	Turn-off Delay Time		-	45	-	ns
tr	Turn-off Fall Time		-	46	-	ns
IS			-	-	-2.3	А
ISM			-	-	-8	А
VSD	Drain to Source Diode Forward Voltage	Vgs = 0V, Is = -2A	-	-	-1.2	V

Electrical Characteristics (TJ=25°C, unless otherwise noted)

Note :

1 The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2 、The data tested by pulsed , pulse width riangle 300us , duty cycle riangle 2%

3. The power dissipation is limited by 150°C junction temperature

4. The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.



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Typical Characteristics

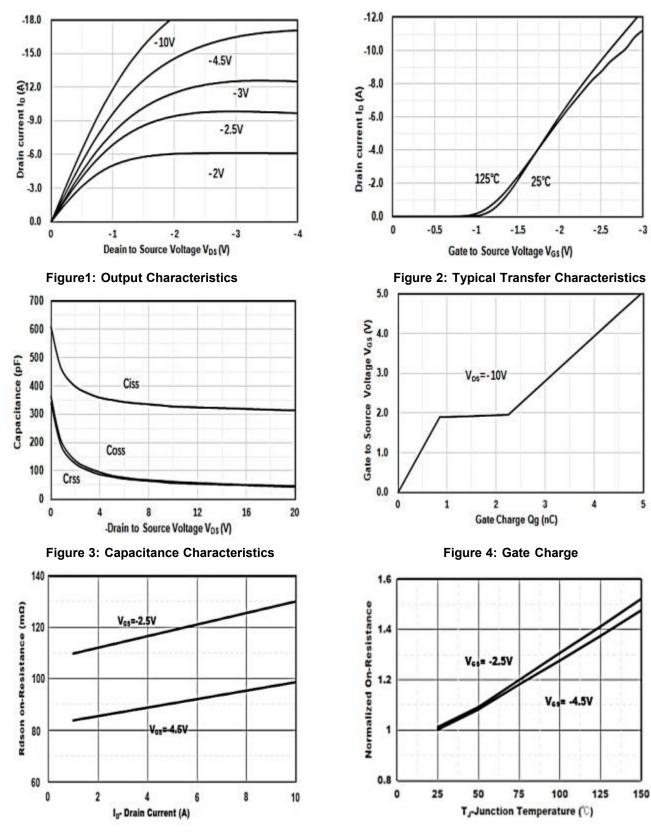
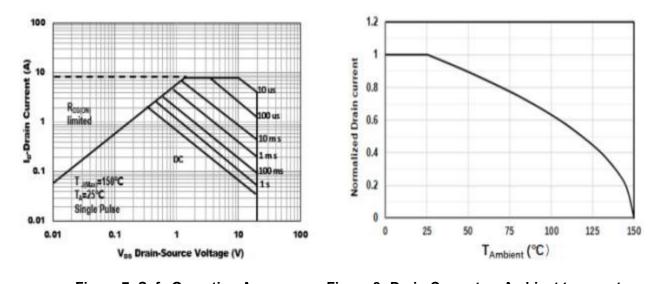


Figure 5: Drain-Source on Resistance

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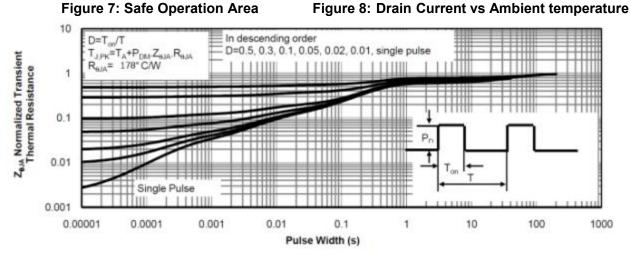
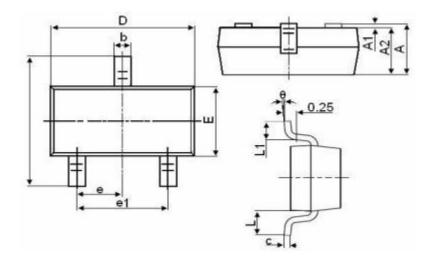


Figure 9: Normalized Maximum Transient Thermal Impedance



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Package Mechanical Data-SOT23-XC-Single



Symbol	Dimensions in Millimeters			
Symbol	MIN.	MAX.		
A	0.900	1.150		
A1	0.000	0.100		
A2	0.900	1.050		
b	0.300	0.500		
с	0.080	0.150		
D	2.800	3.000		
E	1.200	1.400		
E1	2.250	2.550		
е	0.950TYP			
e1	1.800	2.000		
L	0.550REF			
L1	0.300	0.500		
θ	0°	8°		



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Edition	Date	Change	
REV1.0	2021/4/31	Initial release	

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